

### **Description**

The AON7506-HXY uses advanced trench technology

to provide excellent  $R_{DS(ON)}$ , low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

## **General Features**

V<sub>DS</sub> = 30V I<sub>D</sub> =50 A

 $R_{DS(ON)}$  < 10m $\Omega$  @  $V_{GS}$ =10V

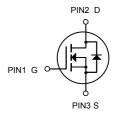
## **Application**

Battery protection

Load switch

Uninterruptible power supply





N-Channel MOSFET

## **Package Marking and Ordering Information**

Product ID	Pack	Marking	Qty(PCS)
AON7506-HXY	DFN3X3-8L	50N03 XXX YYYY	5000

## Absolute Maximum Ratings (T<sub>C</sub>=25 ℃ unless otherwise noted)

Symbol	Parameter	Rating	Units
Vos	Drain-Source Voltage	30	V
Vgs	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	50	А
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	30	А
I <sub>D</sub> @T <sub>A</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	11	А
I <sub>D</sub> @T <sub>A</sub> =70°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	9	А
Ідм	Pulsed Drain Current <sup>2</sup>	112	А
EAS	Single Pulse Avalanche Energy³	24.2	mJ
las	Avalanche Current	22	А
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	37.5	W
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation <sup>4</sup>	2.42	W
Тѕтс	Storage Temperature Range	-55 to 175	°C
TJ	Operating Junction Temperature Range	-55 to 175	°C
ReJA	Thermal Resistance Junction-Ambient <sup>1</sup>	62	°C/W
R <sub>θ</sub> JC	Thermal Resistance Junction-Case <sup>1</sup>	4	°C/W



# Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
∆BVpss/∆Tj	BVDSS Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =1mA		0.0193		V/°C
Б	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =30A		7.5	10	
Rds(on)		V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A		11	18	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage		1.2		2.5	V
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA		-3.97		mV/°C
la a a	Busin Course Look Co. 1	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	- uA
IDSS	Drain-Source Leakage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5	
Igss	Gate-Source Leakage Current	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =30A		34		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.8		Ω
Qg	Total Gate Charge (4.5V)			9.8		
Qgs	Gate-Source Charge	V <sub>DS</sub> =15V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A		4.2		nC
Q <sub>gd</sub>	Gate-Drain Charge			3.6		1
Td(on)	Turn-On Delay Time			4		
Tr	Rise Time	V <sub>DD</sub> =15V , V <sub>GS</sub> =10V ,		8		
T <sub>d(off)</sub>	Turn-Off Delay Time	R <sub>G</sub> =3.3 I <sub>D</sub> =15A		31		ns
Tf	Fall Time	ID- IOA		4		
Ciss	Input Capacitance			940		
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		131		pF
Crss	Reverse Transfer Capacitance			109		
Is	Continuous Source Current <sup>1,5</sup>				43	Α
Ism	Pulsed Source Current <sup>2,5</sup>	-V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			112	Α
Vsp	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1	V
t <sub>rr</sub>	Reverse Recovery Time	IF=30A , dI/dt=100A/μs ,		8.5		nS
Qrr	Reverse Recovery Charge			2.2		nC

#### Note:

<sup>1 .</sup>The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

<sup>2.</sup>The data tested by pulsed , pulse width  $\leqq 300 us$  , duty cycle  $\leqq 2\%$ 

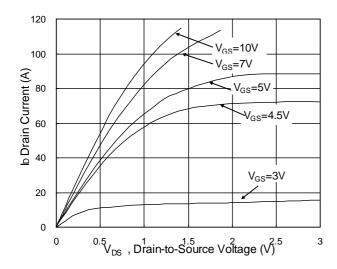
<sup>3 .</sup>The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}$ =25V, $V_{\text{GS}}$ =10V,L=0.1mH, $I_{\text{AS}}$ =22A

<sup>4.</sup> The power dissipation is limited by 175°C junction temperature

<sup>5.</sup> The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



## **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

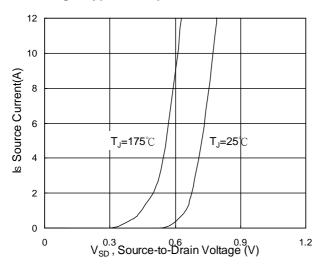


Fig.3 Forward Characteristics of Reverse

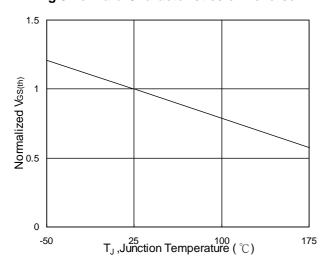


Fig.5 Normalized  $V_{\text{GS(th)}}$  vs.  $T_J$ 

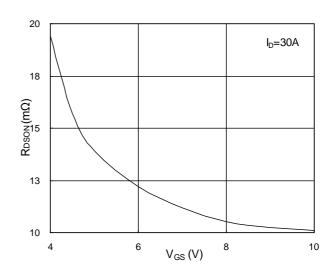


Fig.2 On-Resistance vs. G-S Voltage

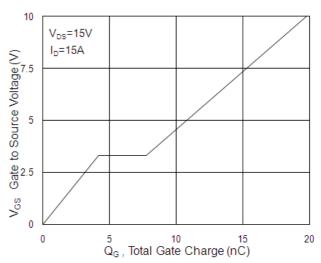


Fig.4 Gate-Charge Characteristics

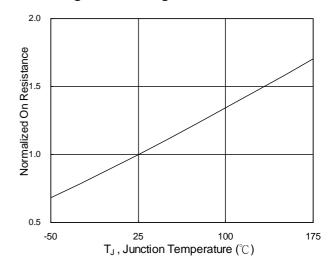
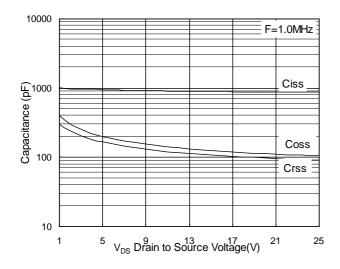


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>



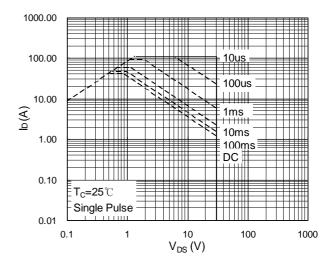


Fig.7 Capacitance

Fig.8 Safe Operating Area

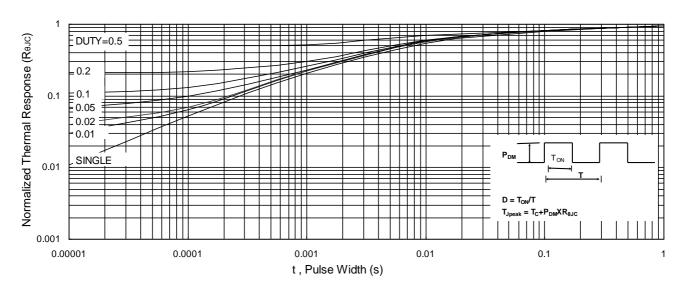
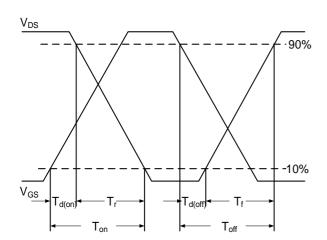


Fig.9 Normalized Maximum Transient Thermal Impedance





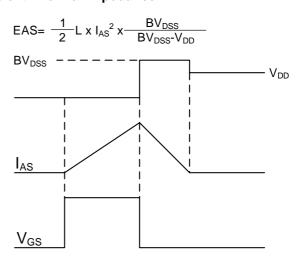
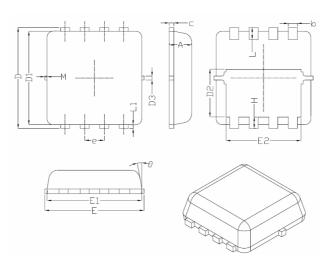


Fig.11 Unclamped Inductive Switching Waveform



# **DFN3X3-8L Package Information**



Complete	Dimensions In Millimeters			
Symbol	Min.	Nom.	Max.	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
С	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.10	3.20	
D2	1.48	1.58	1.68	
D3	-	0.13	-	
E	3.20	3.30	3.40	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
е	0.65BSC			
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1	-	0.13	-	
M	*	*	0.15	
θ		10 <sup>°</sup>	12 <sup>°</sup>	



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